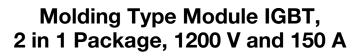
VS-GB150TH120U

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ROHS COMPLIANT





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PRIMARY CHARACTERISTICS					
V _{CES} 1200 V					
I _C at T _C = 80 °C	150 A				
$V_{CE(on)}$ (typical) at I _C = 150 A, T _J = 25 °C	3.10 V				
Speed	8 kHz to 30 kHz				
Package	Dual INT-A-PAK				
Circuit configuration	Half bridge				

FEATURES

- 10 µs short circuit capability
- Low switching losses
- · Rugged with ultrafast performance
- V_{CE(on)} with positive temperature coefficient
- · Low inductance case
- Fast and soft reverse recovery antiparallel FWD
- Isolated copper baseplate using DCB (Direct Copper Bonding) technology
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

- Inductive heating
- Electronic welder
- · Switching mode power supplies

DESCRIPTION

Vishay's IGBT power module provides ultrafast switching speed as well as short circuit ruggedness. It is designed for applications such as electronic welder and inductive heating.

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$ unless otherwise noted)					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter voltage	V _{CES}		1200	V	
Gate to emitter voltage	V _{GES}		± 20	v	
Collector current	1	T _C = 25 °C	219		
	I _C	T _C = 75 °C	150		
Pulsed collector current	I _{CM} ⁽¹⁾	t _p = 1 ms	300	А	
Diode continuous forward current	I _F	T _C = 80 °C	150		
Diode maximum forward current	I _{FM} ⁽¹⁾	t _p = 1 ms	300		
Maximum power dissipation	PD	T _J = 150 °C	1157	W	
Short circuit withstand time	T _{SC}	T _J = 125 °C	10	μs	
RMS isolation voltage	VISOL	f = 50 Hz, t = 1 min	2500	V	

Note

⁽¹⁾ Repetitive rating: pulse width limited by maximum junction temperature

IGBT ELECTRICAL SPECIFICATIONS ($T_c = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	V _{(BR)CES}	T _J = 25 °C	1200	-	-	
Collector to emitter saturation voltage	V	V_{GE} = 15 V, I _C = 150 A, T _J = 25 °C	-	3.00	3.45	v
	V _{CE(sat)}	$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 150 \text{ A}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	3.80	-	
Gate to emitter threshold voltage	V _{GE(th)}	V_{CE} = V_{GE} , I_C = 6.0 mA, T_J = 25 °C	4.5	5.4	6.5	
Collector cut-off current	I _{CES}	$V_{CE} = V_{CES}, V_{GE} = 0 \text{ V}, \text{ T}_{J} = 25 ^{\circ}\text{C}$	-	-	5.0	mA
Gate to emitter leakage current	I _{GES}	$V_{GE} = V_{GES}, V_{CE} = 0 \text{ V}, \text{ T}_{J} = 25 ^{\circ}\text{C}$	-	-	400	nA

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SWITCHING CHARACTERISTICS	5					
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-on delay time	t _{d(on)}		-	71	-	
Rise time	t _r		-	52	-	ns mJ
Turn-off delay time	t _{d(off)}	V _{CC} = 600 V, I _C = 150 A, R _g = 6.8 Ω,	-	429	-	
Fall time	t _f	$V_{GE} = \pm 15 \text{ V}, \text{ T}_{J} = 25 \text{ °C}$	-	116	-	
Turn-on switching loss	E _{on}		-	9.2	-	
Turn-off switching loss	E _{off}		-	7.0	-	
Turn-on delay time	t _{d(on)}		-	71	-	
Rise time	t _r		-	54	-	ns
Turn-off delay time	t _{d(off)}	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 150 \text{ A}, \text{ R}_{g} = 6.8 \Omega,$	-	456	-	
Fall time	t _f		-	134	-	
Turn-on switching loss	E _{on}		-	13.2	-	
Turn-off switching loss	E _{off}		-	8.3	-	mJ
Input capacitance	Cies		-	11.0	-	
Output capacitance	C _{oes}	V _{GE} = 0 V, V _{CE} = 30 V, f = 1.0 MHz	-	1.14	-	nF
Reverse transfer capacitance	C _{res}		-	0.50	-	
SC data	I _{SC}	$\begin{array}{l} t_p \leq 10 \; \mu s, V_{GE} = 15 \; V, T_J = 125 \; ^{\circ}C, \\ V_{CC} = 900 \; V, V_{CEM} \leq 1200 \; V \end{array}$	-	950	-	А
Internal gate resistance	Rg		-	1.3	-	Ω
Stray inductance	L _{CE}		-	-	30	nH
Module lead resistance, terminal to chip	R _{CC'+EE'}	T _C = 25 °C	-	0.35	-	mΩ

DIODE ELECTRICAL SPECIFICATIONS ($T_c = 25$ °C unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Forward voltage	V _F	I _F = 150 A, V _{GE} = 0 V	T _J = 25 °C	-	1.80	2.25	- V
Forward voltage			T _J = 125 °C	-	1.75	-	
Reverse recovery charge	Q _{rr}		T _J = 25 °C	-	9.1	-	μC
			T _J = 125 °C	-	20.0	-	
		$I_{rr} \qquad I_F = 150 \text{ A}, \text{ V}_R = 600 \text{ V}, \\ dI_F/dt = -2000 \text{ A}/\mu \text{s} \\ V_{GF} = -15 \text{ V}$	T _J = 25 °C	-	153	-	٨
Peak reverse recovery current	Irr		T _J = 125 °C	-	191	-	A
Reverse recovery energy	E _{rec}		T _J = 25 °C	-	3.2	-	
			T _J = 125 °C	-	7.5	-	mJ

THERMAL AND MECHANICAL SPECIFICATIONS								
PARAMETER		SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Maximum junction temperature)	TJ		-	-	150		
Operating junction temperature	e range	TJ		-40	-	125	°C	
Storage temperature range		T _{STG}		-40	-	125	1	
Junction to case	IGBT	$R_{ hetaJC}$		-	-	0.108		
	Diode			-	-	0.200		
	IGBT			-	0.031	-	K/W	
Case to heatsink	Diode	$R_{\theta CS}$		-	0.057	-		
	Module			-	0.010	-		
Mounting to you o			Power terminal screw: M5	2.5	-	5.0	Nm	
Mounting torque			Mounting screw: M6	3.0	-	5.0		
Weight			Weight of module	-	300	-	g	

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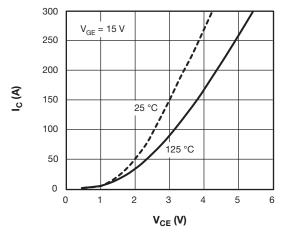


Fig. 1 - IGBT Typical Output Characteristics

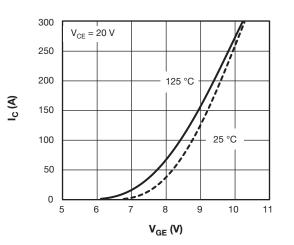
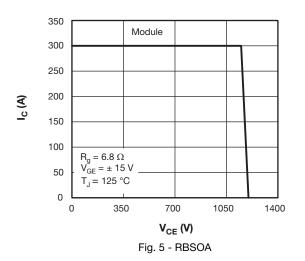
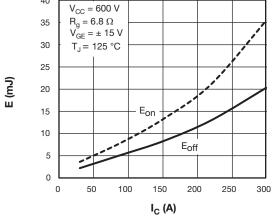


Fig. 2 - IGBT Typical Transfer Characteristics





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Fig. 3 - IGBT Switching Loss vs. I_C

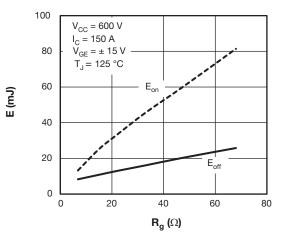


Fig. 4 - IGBT Switching Loss vs. R_q

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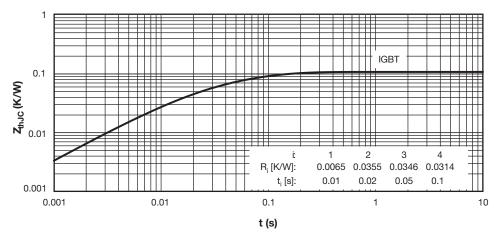
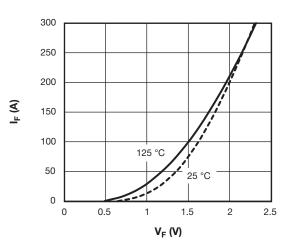


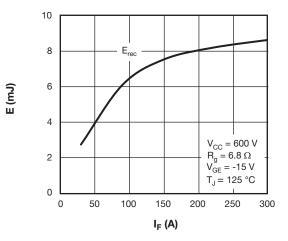
Fig. 6 - IGBT Transient Thermal Impedance



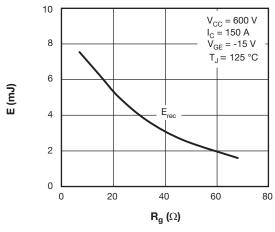
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Fig. 7 - Diode Typical Forward Characteristics





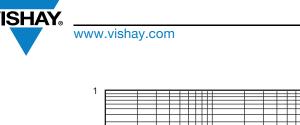




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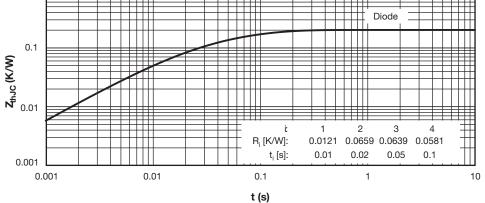
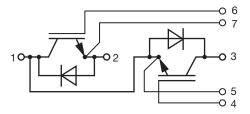


Fig. 10 - Diode Transient Thermal Impedance

CIRCUIT CONFIGURATION



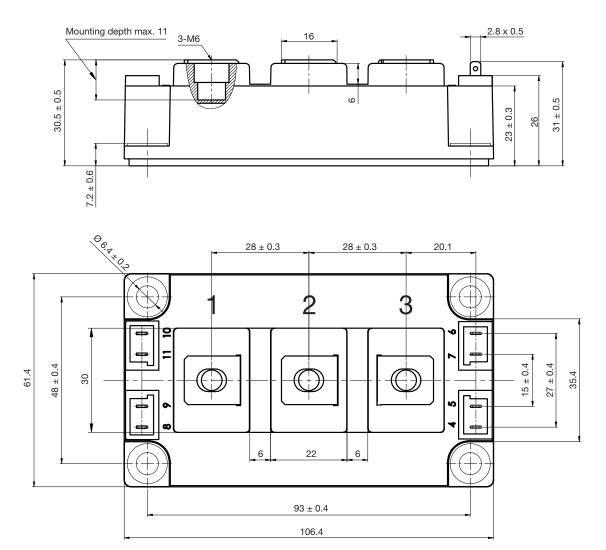
LINKS TO RELATED DOCUMENTS			
Dimensions	www.vishay.com/doc?95525		



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Double INT-A-PAK

DIMENSIONS in millimeters (inches)





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